GAP PADS SILICONE FREE TCGF-SERIES 5,0 W/m*K



Thermally conductive gap fillers offer, besides excellent thermal properties, the ability to even out small, medium and big gaps and tolerances between the component (hot spot) and the cooling device.

The basic material of non-silicone gap fillers is Acrylic. Non-silicone gap fillers are tacky by nature for easy application. The use of an adhesive tape is not necessary in most cases. Anyway a single- or double-sided adhesive is available on request.

- Thermal conductivity: 5,0 W/m*K
- Available in 400x200 mm standard sheet size, other dimensions and die-cut parts on request
- Available in thicknesses from 0,5 to 10,0 mm
- Naturally tacky for easy application
- Low thermal resistance at low pressure
- Non-silicone and no oil bleeding issue











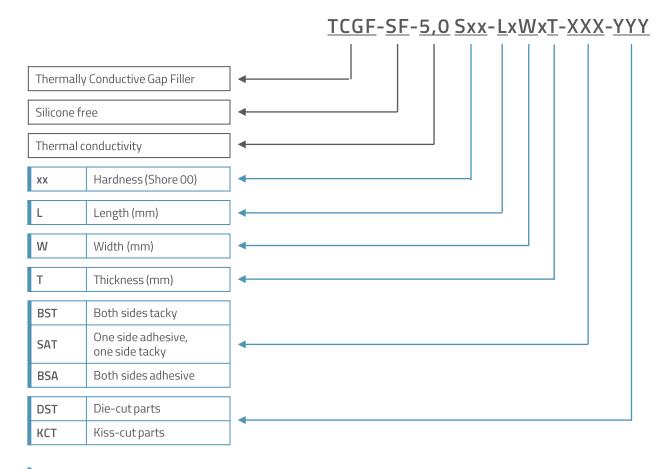


PRODUCT SPECIFICATIONS

PROPERTY	VALUE / TOLERANCE	TEST METHOD
THERMAL		
Thermal conductivity	5,0 W/m*K	ASTM D5470
ELECTRICAL		
Breakdown voltage	≥8 kV/mm	ASTM D149
Volume resistivity	2,1x10 ¹³ Ω−cm	ASTM D257
PHYSICAL		
Composition	Acrylic elastomer	-
Hardness	60 Shore 00	ASTM D2240
Gravity	3,3 g/cm³	ASTM D792
Thickness range	0,5 – 10,0 mm	-
Standard sheet size	400x200mm	-
Working temperature	-40 − 125 °C	-
Flammability rating	V-0	UL 94
Dialectric constant	12,6 MHz	ASTM D150



BUILDING AN ITEM NUMBER



Standard options

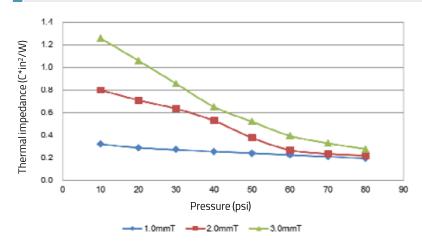
EXAMPLE

TCGF-SF-5,0 S60-400x200x2-SAT-DST

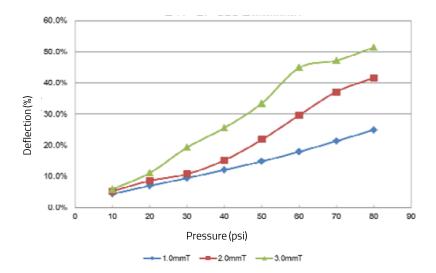
Non-silicone thermally conductive gap filler; thermal conductivity: 5,0 W/m*K; hardness: 60 Shore 00; size: 400x200 mm; thickness: 2 mm; one side adhesive, one side tacky; die-cut parts



THERMAL IMPEDANCE VS. PRESSURE



DEFLECTION



TOLERANCES

THICKNESS		WIDTH AND HEIGTH	
0 – 0,50 mm	+/- 0,05 mm	0 – 50 mm	+/- 0,5 mm
0,60 – 15 mm	+/- 10%	> 50 mm	+/- 1,0 mm

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